

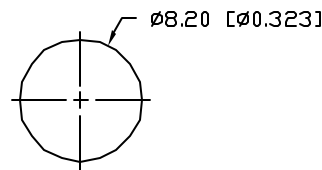
ELECTRO-OPTICAL CHARACTERISTICS $T_A=25^{\circ}\text{C}$ $I_f=20\text{mA}$

PARAMETER	MIN	TYP	MAX	UNITS	TEST COND
PEAK WAVELENGTH		525		nm	
FORWARD VOLTAGE		3.7	4.1	V_f	
REVERSE VOLTAGE	5.0			V_r	$I_r=100\mu\text{A}$
AXIAL INTENSITY		14000		mcd	$I_f=20\text{mA}$
VIEWING ANGLE		20		2x theta	
EMITTED COLOR:	GREEN				
EPOXY LENS FINISH:	WATER CLEAR				

NOTES:

1. SSL-LX5093UPGC/D, GREEN LED. TRIM LEADS TO 5mm.
2. SSI-LXR4815, CHROME HOUSING.
3. LXP-WA-3B16, RUBBER GASKET.
4. SSH-LXH4815BSG, BLACK NYLON BUSHING. (NOT SEEN)
5. ANODE LEAD: LXP-WST24RDT0C, RED INSULATION, CUT 160mm LONG, STRIP 2.0mm & 9.5mm.
6. CATHODE LEAD: LXP-WST24BLT0C, BLACK INSULATION, CUT 160mm LONG, STRIP 2.0mm & 9.5mm.
7. THREAD LEADS THROUGH BUSHING, INSERT INTO HOUSING, BACKFILL WITH SILICON ADHESIVE, INSERT BUSHING INTO HOUSING. CRIMP INTO PLACE.
8. WATER RESISTANT PER NEMA STANDARD 250, SECTION 6.7.

PANEL CUTOUT



LIMITS OF SAFE OPERATION AT 25°C

PARAMETER	MAX	UNITS
PEAK FORWARD CURRENT*	150	mA
STEADY CURRENT	30	mA
POWER DISSIPATION	120	mW
DERATE FROM 25°C	-1.48	mW/°C
OPERATING, STORAGE TEMP.	-40 TO +85	°C
SOLDERING TEMP.	+260	°C
2.0mm FROM BODY		3 SEC. MAX

* $t < 10\mu\text{s}$

*UNLESS OTHERWISE SPECIFIED TOLERANCES PER DECIMAL PRECISION ARE: X=±1 (±0.039), X.X=±0.5 (±0.020), X.XX=±0.25 (±0.010), X.XXX=±0.127 (±0.005), LEAD SIZE=±0.08 (±0.002), LEAD LENGTH=±0.75 (±0.030), MIN.=^{+DECIMAL PRECISION}-0.00, MAX.=^{+0.00}-DECIMAL PRECISION

REV.

PART NUMBER

SSI-LXR4815-Q21742

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T-5mm 525nm GREEN LED PANEL INDICATOR LED,
WATER CLEAR LENS, 6" WIRE LEADS, SPLASH RESISTANT.

RELIABILITY NOTE
OUR MANY YEARS OF EXPERIENCE DATA ACCUMULATION INDICATE THAT SOLDER HEAT IS A MAJOR CAUSE OF EARLY AND FUTURE FAILURE. PLEASE PAY ATTENTION TO YOUR SOLDERING PROCESS.

DRAWN BY: GT	CHECKED BY:	APPROVED BY:	DATE: 10.1.03
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			SCALE: N/A